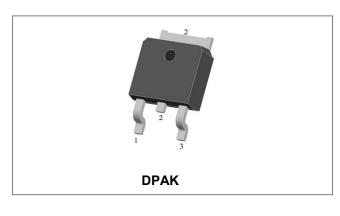


# STD30300

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# STD30300 SCHOTTKY RECTIFIER



#### Features

- 150°C T<sub>J</sub> operation
- Ultralow forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Trench MOS Schottky technology
- Terminals finish: 100% Pure Tin
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

### **Circuit Diagram**



#### **Applications**

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection

#### Maximum Ratings(limiting values, at 25 °C unless otherwise specified)

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	-	300	V
Average Rectified Forward Current	I <sub>F (AV)</sub>	Tc=108°C, In DC	30	A
Peak One Cycle Non-Repetitive Surge Current	I <sub>FSM</sub>	8.3ms, Half Sine pulse	200	А

#### **Electrical Characteristics:**

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop*	V <sub>F1</sub>	@ 30A, Pulse, T <sub>J</sub> = 25 °C	0.92	0.94	V
	V <sub>F2</sub>	@ 30A, Pulse, T <sub>J</sub> = 125 °C	0.80	0.82	V
Reverse Current*	I <sub>R1</sub>	$@V_R = rated V_R$ T <sub>J</sub> = 25 °C	0.08	100	uA
	I <sub>R2</sub>	$@V_R = rated V_R$ T <sub>J</sub> = 125 °C	0.2	10	mA
Junction Capacitance	Ст	@V <sub>R</sub> = 5V, T <sub>C</sub> = 25 °C, f <sub>SIG</sub> = 1MHz	383	-	pF

\* Pulse width < 300 µs, duty cycle < 2%

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# STD30300

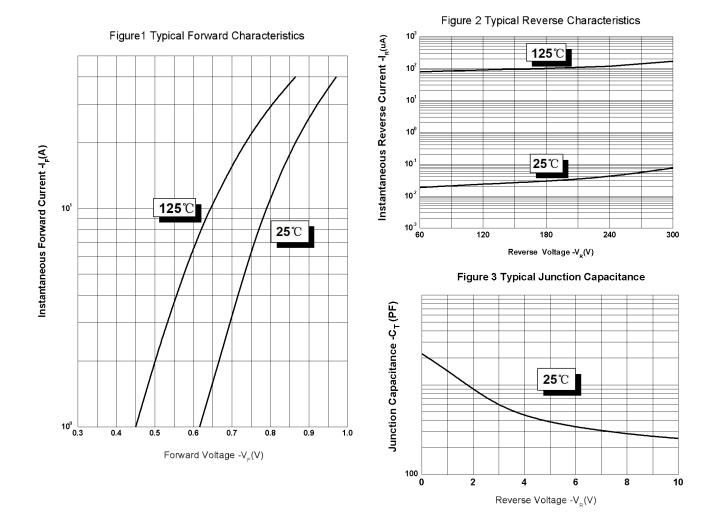
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### **Thermal-Mechanical Specifications:**

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +150	°C
Storage Temperature	T <sub>stg</sub>	-	-55 to +150	°C
Typical Thermal Resistance Junction to Case	$R_{ ext{ heta}JC}$	DC operation	1.5	°C/W
Approximate Weight	wt	-	0.39	g
Case Style	DPAK			

### **Ratings and Characteristics Curves**





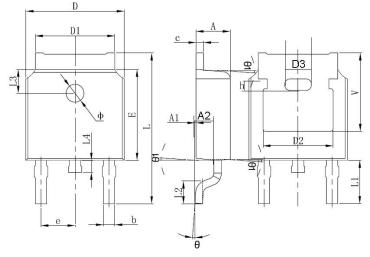
# STD30300

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#### **Mechanical Dimensions DPAK**



The outline from different package houses may have slight differences. So the outline above is just schematic. The dimensions are controlled per specifications.

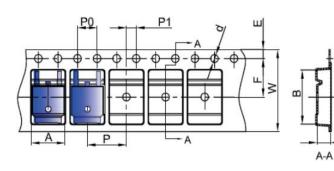
Symbol	Dimensions in millimeters		
	Min.	Typical	Max.
A	2.18	-	2.39
A1	-	-	0.13
b	0.64	-	0.89
С	0.46	-	0.89
D	6.35	-	6.73
D1	4.95	-	5.46
D2	4.32	-	-
E	5.97	6.1	6.22
е	2.29BSC		
L	9.4	-	10.41
L1	2.90 REF.		
L2	1.4	1.52	1.78
L3	1.60 REF.		
L4	-	-	1.02
Φ	1.1	-	1.3
Θ	0°	-	10°
V	5.21	-	-

### **Ordering Information**

Device	Package	Shipping
STD30300	DPAK	2500pcs / reel
STD30300TR	DPAK	2500pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

## **Carrier Tape Specification DPAK**



SYMBOL	Millimeters		
STIVIDOL	Min.	Max.	
A	6.80	7.00	
В	10.40	10.60	
С	2.60	2.80	
d	Ф1.45	Ф1.65	
E	1.65	1.85	
F	7.40	7.60	
P0	3.90	4.10	
Р	7.90	8.10	
P1	1.90	2.10	
W	15.90	16.30	

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## **Marking Diagram**



Where XXXXX is YYWWL

ST

D

30

300

SSG

ŴŴ

YY

L

- = Device Type
- = Package type = Forward Current (30A)
- = Reverse Voltage (300V) = SSG
- = Year

= Week

= Lot Number

Cautions: Molding resin Epoxy resin UL:94V-0



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